

# EVAL-RHF330V1

### EVAL-RHF330V1 evaluation board

#### Data brief

### Features

- Mounted Engineering Model RHF330K1: Rad-hard, 1.0 GHz, operational amplifier (see RHF330 datasheet for further information)
- Mounted components (ready-to-use)
- Material: two-layered FR-4
- PCB thickness: 1.6 mm
- Copper thickness: 35 μm
- Analog connections: SMA
- Supply connections: banana 2 mm

### Description

This data brief describes the EVAL-RHF330V1 evaluation board.

This evaluation board is a ready-to-use, configurable hardware which allows designers to efficiently test a target device. A unique PCB is used in different configurations to support the radiation-hardened (rad-hard), operational amplifier devices.

This document shows the components incorporated on the EVAL-RHF330V1 evaluation board and suggests several ways to use the board.

The EVAL-RHF330V1 evaluation board is intended only for evaluation purposes.

### Table 1. Evaluation board summary

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Evaluation board part number		Device part number	Operation amplifier		
	EVAL-RHF330V1	RHF330	1.0 GHz high-speed signal conditioning		



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January 2013

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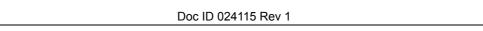


# 1 Bill of material

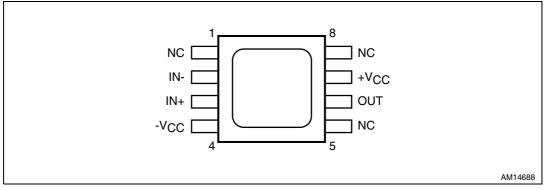
Table 2. Bill of material			
Designator	Footprint	Part type	Description
C1	1210		
C3	0805	100 μF By	Bypass ceramic capacitor on V <sub>CC</sub>
C4	0805		Bypass ceramic capacitor on V <sub>CC</sub>
C6	1210		
IC1	FLAT 8	RHF330	DUT
J1		Red	
J2	Banana 2 mm	Black	Banana 2 mm supply connectors
J3	1	Blue	
J4			
J5		SMA	SMA connector
J6	SMA		
J7	-		
J8			
R1		50 Ω - 1 %	
R2			SMD resistor
R4	-	300 Ω - 1 %	
R6	0603		
R8		NC	
R9		0 Ω	
C8	1		
C2	0805		
C5	0805		
C7		NC <sup>(1)</sup>	-
R3	0603		
R5			
R7	1		

1. NC = not connected

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## 2 Device pin connections and description



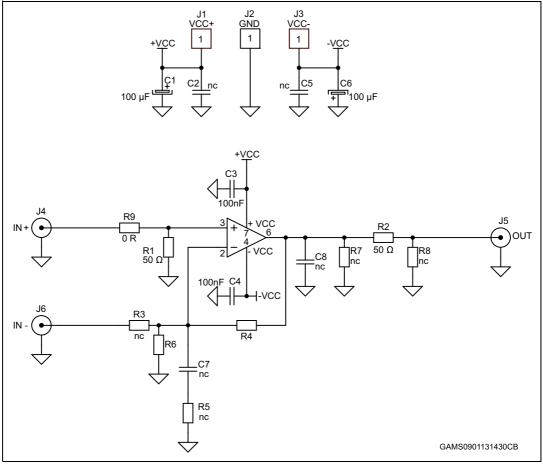
### Figure 1. RHF330 pin connections,

#### Table 3. RHF330 pin description

Name	Pin number	Description
NC	1, 5, 8	Non connected pins
IN-	2	Negative input pin
IN+	3	Positive input pin
-V <sub>CC</sub>	4	Negative supply
OUT	6	Output pin
+V <sub>CC</sub>	7	Positive supply

## 3 Evaluation board schematic

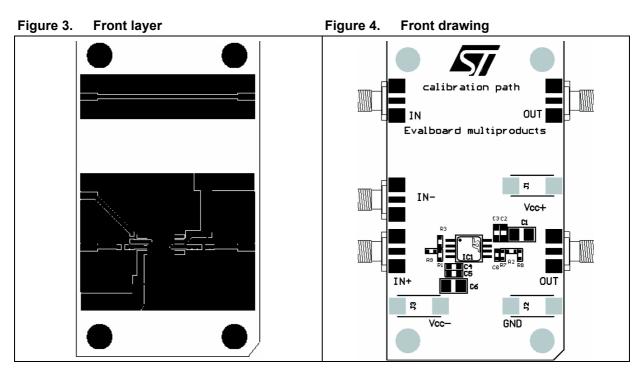
Figure 2. EVAL-RHF330V1 full layout schematic

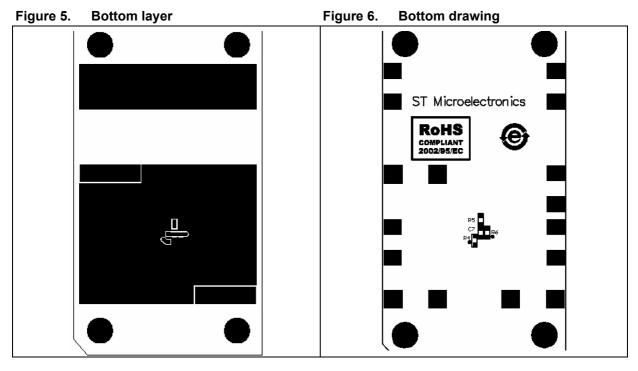




## 4 PCB print out

The PCB is a two-layered FR-4 material which is 1.6 mm thick. The copper thickness is 35  $\mu\text{m}$ 





### 5 Evaluation board description

The PCB is designed for 50-ohm generators and receivers. A 50-ohm calibration path can be used for high speed products.

Capacitor C8 can be used to load the output. Capacitor C7 and resistor R5 can be used to stabilize the product.

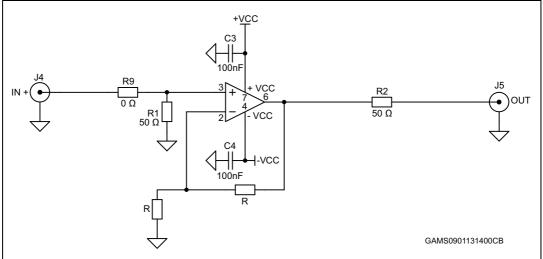
Pi resistors R7, R2, and R8 are used to adapt impedance between the output load and the hardware tool. For example, to load the device under test (DUT) with 150  $\Omega$  when the analyzer is 50  $\Omega$  input impedance, use the following equations for each respective resistor:

- R7 = 2.2 kΩ
- R2 = 130 Ω
- R8 = 82 Ω

A 100-nF and a 100- $\mu$ F capacitor are soldered onto each supply. A third supply place is kept free in case an additional bypass capacitor is needed.

Resistors (R) mounted on the board are placed to get a positive gain of two by the DUT as shown in *Figure 7*.

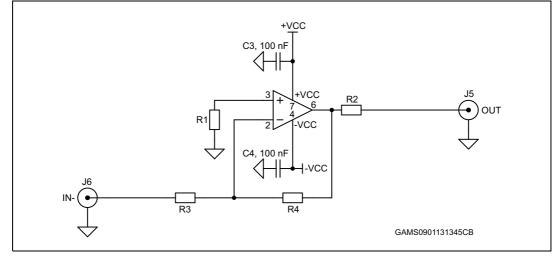
#### Figure 7. Positive gain of two schematic





The layout in *Figure 8* allows the DUT to be tested with a negative gain.





Other configurations such as an integrator or a differentiator can also be used.



# 6 Revision history

### Table 4.Document revision history

Date	Revision	Changes
25-Jan-2013	1	Initial release.



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